

RBC50A65B1UFWA

650V - 50A - Fast Recovery Diode

R07DS1506EJ0120 Rev.1.20 Oct.18th.2024

Features

• Forward voltage: V_F = 1.7 V typ. (at I_F = 50 A)

· High speed switching

• Applications: UPS, Welding, photovoltaic inverters, Power converter system

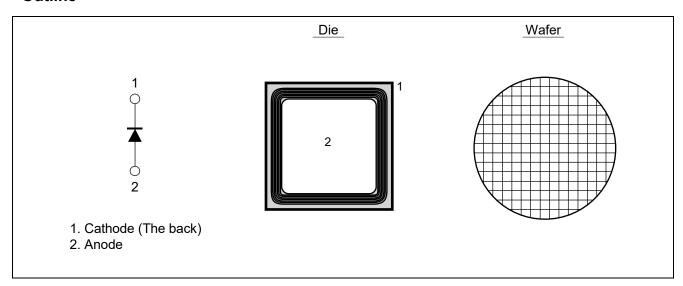
• Unsawn wafer Wafer size = 200 mm

• Quality grade: Standard

Key performance

| Product name | V _R | lF | Die size | Package |
|----------------|-----------------------|------|----------------------|--------------|
| RBC50A65B1UFWA | 650 V | 50 A | 16.0 mm ² | Unsawn wafer |
| | | | (4.0 mm x 4.0 mm) | |

Outline



Mechanical parameter

| Die size | 4.00 x 4.00 mi | | |
|------------------------|----------------|--|--|
| Area total | 16.00 | | |
| Thickness | 0.077 typ. | | |
| Wafer size | 193.9 | | |
| Passivation front side | Polyimide | | |
| Pad metal | AlSi – 5.2 μm | | |
| Backside metal | Ni/Au | | |

Absolute Maximum Ratings

(Tj = 25 °C unless otherwise noted)

| Item | Symbol | Ratings | Unit |
|-------------------------|-----------------------|------------|------|
| Maximum reverse voltage | V _{RM} | 650 | V |
| Forward current | lF | Notes1 | Α |
| Junction temperature | T _j Notes2 | 175 Notes2 | °C |

Notes: 1. Depends on thermal properties of assembly. Tj = 175 °C.

- 2. Please use this device in the thermal conditions which the junction temperature does not exceed 175 $^{\circ}$ C.
- 3. Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for Handling and Usage of Semiconductor Devices) and individual reliability data.

Electrical Characteristics

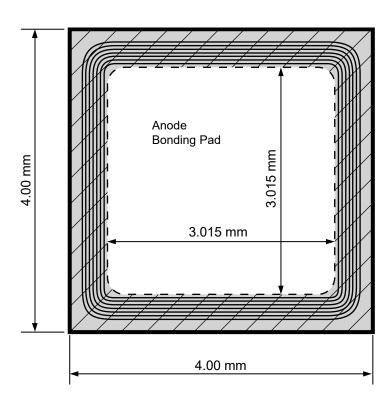
(Tj = 25 °C unless otherwise noted)

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------|----------------|-----|-----|-----|------|------------------------------------|
| Forward voltage | V _F | | 1.7 | 2.2 | V | I _F = 50 A Notes5, 6, 7 |
| Reverse current | I _R | _ | _ | 10 | μΑ | V _{CE} = 650 V Notes4 |
| Reverse voltage | V_R | 650 | _ | _ | V | I _R = 100 μA Notes4, 5 |

Notes: 4. Tested on wafer

- 5. Pulse test
- 6. Designed target value on Renesas measurement condition. (Not tested)
- 7. Characteristic value on TO-247 package
- 8. Characteristic items prescribed in this document will guarantee the electrical characteristics in chip state but not the characteristic fluctuations or characteristic defects that occur in the processes after assembling.
- 9. Switching characteristics is depending strongly on module design and mounting technology and can therefore not be specified for a bare die.
- 10. Please refer to "R07DS1383 RBN75H65T1FPQ-A0 Data sheet" for packaged product datasheet.

Die Dimension

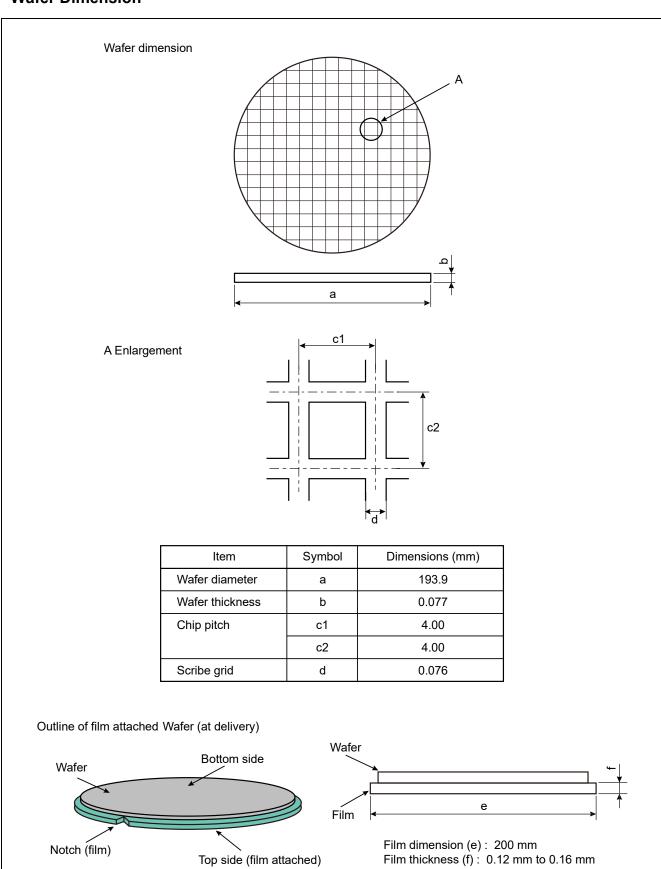


Notes 1:

| Illustration | Definition | |
|---------------------|-------------------|--|
| Part of dotted line | Bonding area | |
| Part of gray | Final passivation | |

Notes 2: Recognition, target and any other patterns which are not related to FRD operation, may be changed without notice.

Wafer Dimension



Ordering Information

Please contact your Renesas sales representative for sample requests.

| Delivery Form | Ordering Part Number | Ordering Quantity Unit |
|---------------|------------------------|------------------------|
| Unsawn wafer | RBC50A65B1UFWA-030#FF0 | 2724 (3 wafers) |
| Unsawn wafer | RBC50A65B1UFWA-0F0#FF0 | 11804 (13 wafers) |

Note. The order quantities indicate the maximum quantity of chips for each part number, and the actual quantity of chips shipped will be reduced due to yield. These is also a possibility that the number of wafers may decrease during the manufacturing process. The quantity shipped will be indicated on the label as the number of good chips.

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